

Special Issue

Nanomaterials in Medical Engineering

Message from the Guest Editor

This Special Issue intends to gather original scientific peer-reviewed articles and review articles featuring important and recent developments or achievements in nanomaterial research, with an emphasis on medical applications and potential applications. Authors who are well-known experts in their domain are invited to submit their contribution at any time until the end of June 2021. Papers can cover either the experimental or theoretical aspect, or both aspects, of nanomaterials (organic, inorganic, or hybrid) in medical applications, including diagnosis, drug delivery, tissue engineering, regenerative medicine, prostheses, and implants.

Guest Editor

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Deadline for manuscript submissions

closed (10 December 2021)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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